

## PATENT ASSIGNMENT

Electronic Version v1.1  
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT										
NATURE OF CONVEYANCE:	ASSIGNMENT										
CONVEYING PARTY DATA											
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Shanggar Periaman</td> <td>03/23/2007</td> </tr> <tr> <td>Kooi C Ooi</td> <td>03/23/2007</td> </tr> <tr> <td>Bok E Cheah</td> <td>03/23/2007</td> </tr> <tr> <td>Yen H Chew</td> <td>09/23/2007</td> </tr> </tbody> </table>		Name	Execution Date	Shanggar Periaman	03/23/2007	Kooi C Ooi	03/23/2007	Bok E Cheah	03/23/2007	Yen H Chew	09/23/2007
Name	Execution Date										
Shanggar Periaman	03/23/2007										
Kooi C Ooi	03/23/2007										
Bok E Cheah	03/23/2007										
Yen H Chew	09/23/2007										
RECEIVING PARTY DATA											
<table border="1"> <tr> <td>Name:</td> <td>Intel Corporation</td> </tr> <tr> <td>Street Address:</td> <td>2200 Mission College Boulevard</td> </tr> <tr> <td>City:</td> <td>Santa Clara</td> </tr> <tr> <td>State/Country:</td> <td>CALIFORNIA</td> </tr> <tr> <td>Postal Code:</td> <td>95052</td> </tr> </table>		Name:	Intel Corporation	Street Address:	2200 Mission College Boulevard	City:	Santa Clara	State/Country:	CALIFORNIA	Postal Code:	95052
Name:	Intel Corporation										
Street Address:	2200 Mission College Boulevard										
City:	Santa Clara										
State/Country:	CALIFORNIA										
Postal Code:	95052										
PROPERTY NUMBERS Total: 1											
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>11728534</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	11728534						
Property Type	Number										
Application Number:	11728534										
CORRESPONDENCE DATA											
<p>Fax Number: (612)677-3572</p> <p>Email: docketing@cpaglobal.com</p> <p><i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i></p> <p>Correspondent Name: Ramin Aghevli</p> <p>Address Line 1: 2200 Mission College Boulevard</p> <p>Address Line 4: Santa Clara, CALIFORNIA 95052</p>											
ATTORNEY DOCKET NUMBER:	P25203										
NAME OF SUBMITTER:	Ramin Aghevli										
<p>Total Attachments: 3</p> <p>source=P25203_EXE_ASSIGN#page1.tif</p> <p>source=P25203_EXE_ASSIGN#page2.tif</p> <p>source=P25203_EXE_ASSIGN#page3.tif</p>											

CH \$40.00 11728534

## ASSIGNMENT

WHEREAS, We, Shanggar Periaman, residing at 32. Tingkat Pahlawan 6, Taman Senangan, 13050, Butterworth, Penang., Malaysia, and Kooi C. Ooi, residing at 259 Lebuhraya Bingham, 11700 Bukit Glugor, Penang, Malaysia, and Bok E. Cheah, residing at 259 Lebuhraya Bingham, 11700 Bukit Glugor, Penang, Malaysia, and Yen H. Chew, residing at 216 Persiaran Gurney, Penang, 10250, Malaysia, made certain new and useful inventions and improvements for which we filed an application for Letters Patent of the United States entitled DIE BACKSIDE WIRE BOND TECHNOLOGY FOR SINGLE OR STACKED DIE PACKAGE;

WHEREAS, We hereby authorize and request our attorneys, associated with **Customer Number 50890**, to insert here in parentheses (SER. No. 11/728,534; Filing Date: March 26, 2007) the filing date and application number of said application when known

AND WHEREAS, Intel Corporation, a corporation organized and existing under and by virtue of the laws of the State of Delaware, and having an office and place of business at 2200 Mission College Blvd., Santa Clara, CA 95052 (hereinafter "Assignee"), is desirous of acquiring the entire right, title and interest in and to said inventions, improvements and application and in and to the Letters Patent to be obtained therefore;

NOW, THEREFORE, to all whom it may concern, be it known that for good and valuable consideration, the receipt and sufficiency whereof is hereby acknowledged, we have sold, assigned, and transferred, and by these presents do sell, assign and transfer unto said Assignee, its successors or assigns, the entire right, title and interest for all countries in and to all inventions and improvements disclosed in the aforesaid application, and in and to the said application, all divisions, continuations, continuations-in-part, or renewals thereof, all Letters Patent which may be granted there from, and all reissues or extensions of such patents, and in and to any and all applications which have been or shall be filed in any foreign countries for Letters Patent on the said inventions and improvements, including an assignment of all rights under the provisions of the International Convention, and all Letters Patent of foreign countries which may be granted there from; and we do hereby authorize and request the Commissioner of

Patents and Trademarks to issue any and all United States Letters Patent for the aforesaid inventions and improvements to the said Assignee as the assignee of the entire right, title and interest in and to the same, for the use of the said Assignee, its successors and assigns.

AND, for the consideration aforesaid, we do hereby agree that we and our executors and legal representatives will make, execute and deliver any and all other instruments in writing including any and all further application papers, affidavits, assignments and other documents, and will communicate to said Assignee, its successors and representatives all facts known to us relating to said improvements and the history thereof and will testify in all legal proceedings and generally do all things which may be necessary or desirable more effectually to secure to and vest in said Assignee, its successors or assigns the entire right, title and interest in and to the said improvements, inventions, applications, Letters Patent, rights, titles, benefits, privileges and advantages hereby sold, assigned and conveyed, or intended so to be.

AND, furthermore, we covenant and agree with said Assignee, its successors and assigns, that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by us and that full right to convey the same as herein expressed is possessed by us.


IN TESTIMONY WHEREOF, I have hereunto set my hand this 23<sup>rd</sup> day of March, 2007.

  
\_\_\_\_\_  
Shangear Periaman

IN TESTIMONY WHEREOF, I have hereunto set my hand this 23<sup>rd</sup> day of March, 2007.

  
\_\_\_\_\_  
Kooi C. Ooi

IN TESTIMONY WHEREOF, I have hereunto set my hand this 23<sup>rd</sup> day of MARCH, 2007.

  
\_\_\_\_\_  
Bok E. Cheah

IN TESTIMONY WHEREOF, I have hereunto set my hand this 23<sup>rd</sup> day of March, 2007.

  
\_\_\_\_\_  
Yen H. Chew